



# RF MOSFET Power Transistor, 5W, 28V

## 500 - 1000 MHz

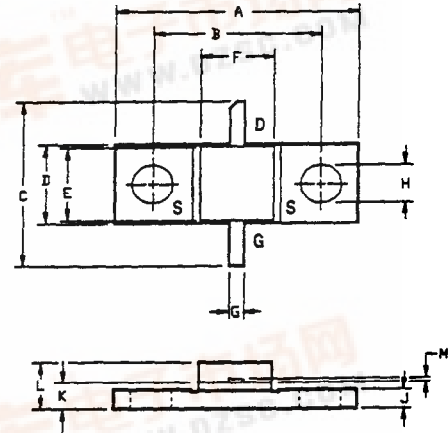
LF2805A

V2.00

### Features

- N-Channel Enhancement Mode Device
- DMOS Structure
- Lower Capacitances for Broadband Operation
- Common Source Configuration
- Lower Noise Floor
- Applications

Broadband Linear Operation  
500 MHz to 1400 MHz



### Absolute Maximum Ratings at 25°C

Parameter	Symbol	Rating	Units
Drain-Source Voltage	$V_{DS}$	65	V
Gate-Source Voltage	$V_{GS}$	20	V
Drain-Source Current	$I_{DS}$	1.4	A
Power Dissipation	$P_D$	14.4	W
Junction Temperature	$T_J$	200	°C
Storage Temperature	$T_{STG}$	-65 to +150	°C
Thermal Resistance	$\theta_{JC}$	12.1	°C/W

LETTER DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	20.70	20.96	.815	.825
B	14.35	14.61	.565	.575
C	13.72	14.22	.540	.560
D	6.27	6.53	.247	.257
E	6.22	6.48	.245	.255
F	6.22	6.48	.245	.255
G	1.14	1.40	.045	.055
H	2.92	3.18	.115	.125
J	1.40	1.65	.055	.065
K	1.96	2.46	.077	.097
L	3.61	4.37	.142	.172
M	.08	.15	.003	.006

### Electrical Characteristics at 25°C

Parameter	Symbol	Min	Max	Units	Test Conditions
Drain-Source Breakdown Voltage	$BV_{DSS}$	65	-	V	$V_{GS}=0.0\text{ V}, I_{DS}=2.0\text{ mA}$
Drain-Source Leakage Current	$I_{DSS}$	-	1.0	mA	$V_{DS}=28.0\text{ V}, V_{GS}=0.0\text{ V}$
Gate-Source Leakage Current	$I_{GSS}$	-	1.0	$\mu\text{A}$	$V_{GS}=20\text{ V}, V_{DS}=0.0\text{ V}$
Gate Threshold Voltage	$V_{GS(TH)}$	2.0	6.0	V	$V_{DS}=10.0\text{ V}, I_{DS}=10.0\text{ mA}$
Forward Transconductance	$G_M$	80	-	mS	$V_{DS}=10.0\text{ V}, I_{DS}=100.0\text{ mA}, \Delta V_{GS}=1.0\text{ V}, 80\ \mu\text{s Pulse}$
Input Capacitance	$C_{ISS}$	-	7	pF	$V_{DS}=28.0\text{ V}, F=1.0\text{ MHz}$
Output Capacitance	$C_{OSS}$	-	5	pF	$V_{DS}=28.0\text{ V}, F=1.0\text{ MHz}$
Reverse Capacitance	$C_{RSS}$	-	2.4	pF	$V_{DS}=28.0\text{ V}, F=1.0\text{ MHz}$
Power Gain	$G_P$	10	-	dB	$V_{DD}=28.0\text{ V}, I_{DQ}=50\text{ mA}, P_{OUT}=5.0\text{ W}, F=1.0\text{ GHz}$
Drain Efficiency	$\eta_D$	50	-	%	$V_{DD}=28.0\text{ V}, I_{DQ}=50\text{ mA}, P_{OUT}=5.0\text{ W}, F=1.0\text{ GHz}$
Load Mismatch Tolerance	VSWR-T	-	20:1	-	$V_{DD}=28.0\text{ V}, I_{DQ}=50\text{ mA}, P_{OUT}=5.0\text{ W}, F=1.0\text{ GHz}$

Specifications Subject to Change Without Notice.

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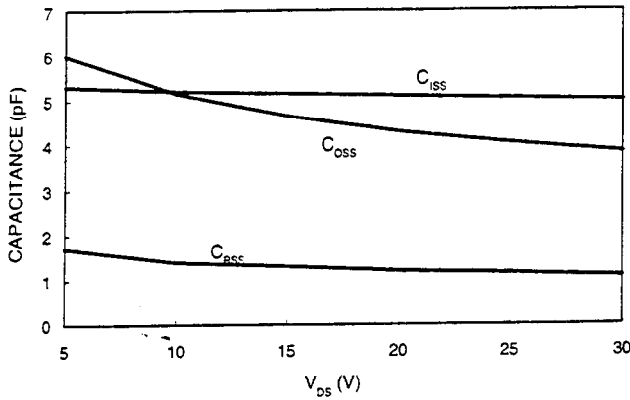
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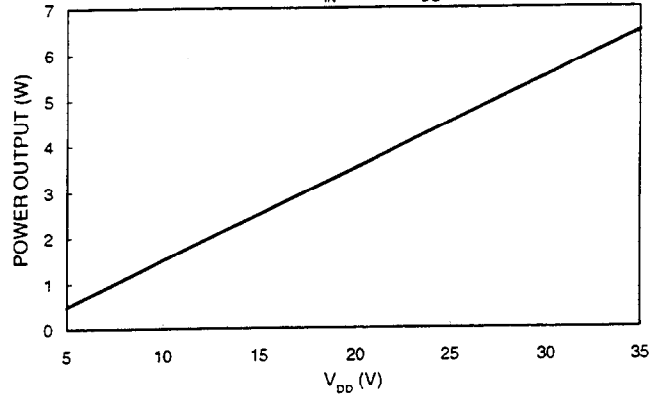


Typical Broadband Performance Curves

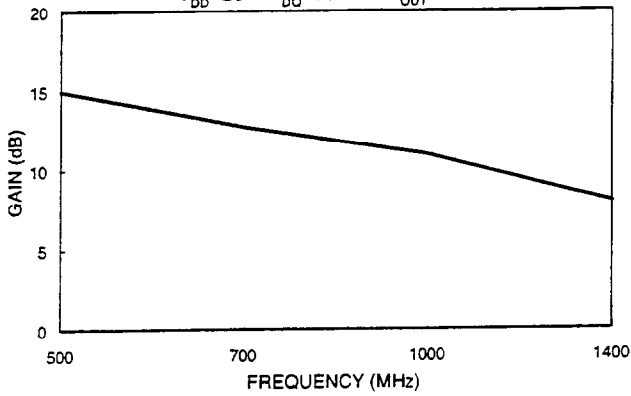
**CAPACITANCES vs VOLTAGE**  
F=1.0 MHz



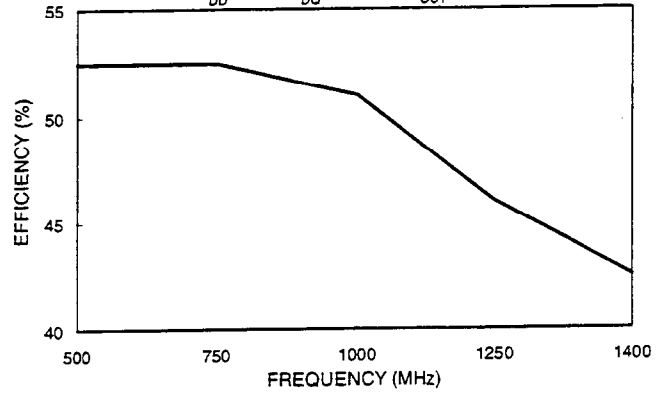
**POWER OUTPUT vs VOLTAGE**  
F=1.0 GHz P<sub>IN</sub>=0.5 W I<sub>DO</sub>=50 mA



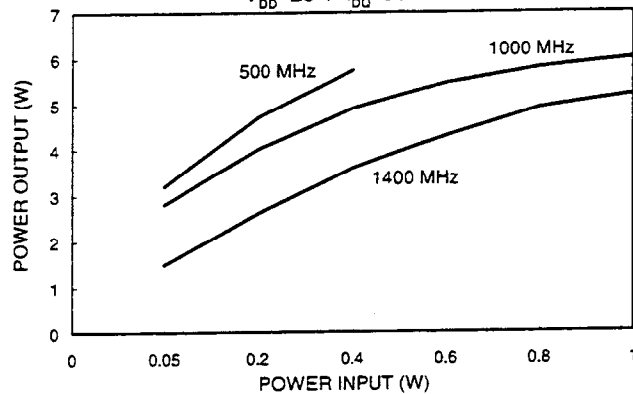
**GAIN vs FREQUENCY**  
V<sub>DD</sub>=28 V I<sub>DO</sub>=50 mA P<sub>OUT</sub>=5.0 W



**EFFICIENCY vs FREQUENCY**  
V<sub>DD</sub>=28 V I<sub>DO</sub>=50 mA P<sub>OUT</sub>=5.0 W



**POWER OUTPUT vs POWER INPUT**  
V<sub>DD</sub>=28 V I<sub>DO</sub>=50 mA



Typical Device Impedance

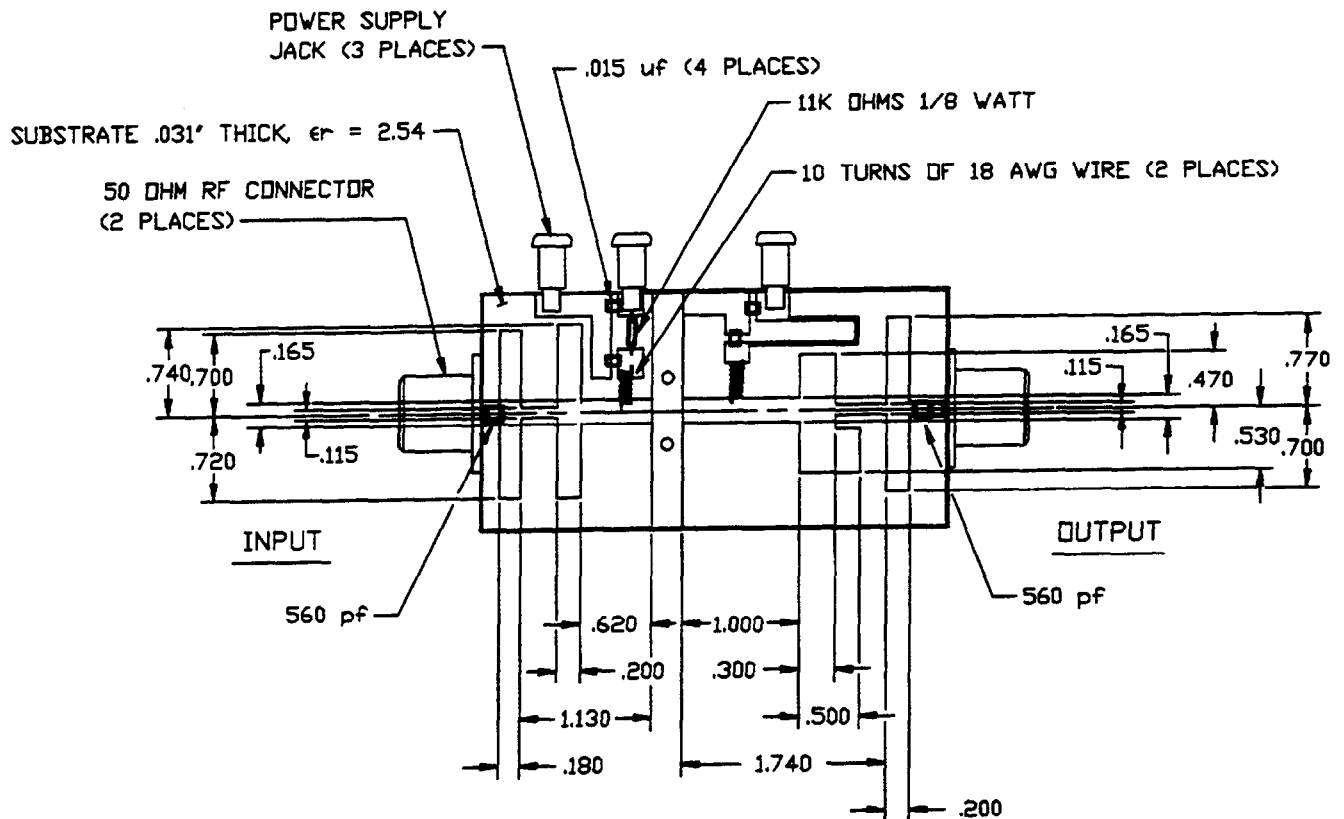
Frequency (MHz)	Z <sub>IN</sub> (OHMS)	Z <sub>LOAD</sub> (OHMS)
500	4.3 - j 29.0	27.3 + j 28.6
1000	2.2 - j 2.75	8.0 + j 16.0
1400	2.8 + j 3.0	9.4 + j 10.6

V<sub>DD</sub>=28 V, I<sub>DO</sub>=50 mA, P<sub>OUT</sub>=5.0 Watts

Z<sub>IN</sub> is the series equivalent input impedance of the device from gate to source.

Z<sub>LOAD</sub> is the optimum series equivalent load impedance as measured from drain to ground.

RF Test Fixture



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